# SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY MODULE

### MODEL NO : SO1602AWGB-UC-WB-U

#### **CUSTOMER : AKZUKI**

**APPROVED SIGNATURE** 

DSGD :

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**DATE : Sep.12.2014** 

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		Revision Rec	cord	
No.	Date	Model No.	Version	Remarks
1	Mar.31.2014	SO1602AWGB-UC-WB-U	REV.0	Smaple RoHS-Compliant
2	Aug.11.2014	SO1602AWGB-UC-WB-U	REV.1	SPE Change P7 SDA_in /SDA_out
3	Aug.18.2014	SO1602AWGB-UC-WB-U	REV.2	SPE Change P7 SDA_in/SDA_out are tied together.
4	Sep.12.2014	SO1602AWGB-UC-WB-U	REV.3	SPE Change P12 Serial Interface Timing IO = SCL / SDA = 2.4-3.6V

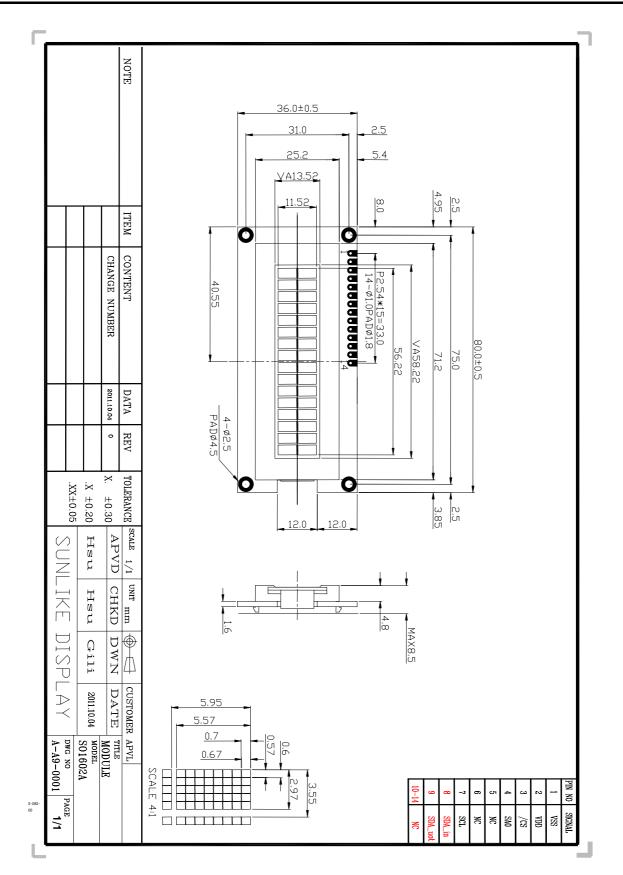
### **GENERAL SPECIFICATION**

ITEM		D	ESCRIPTIO	N							
Product No	SO1602AW	SO1602AWGB-UC-WB-U									
OLED Type	OLED W	OLED White & Black									
Rear Polarizer	Reflectiv	Reflective / Positive									
Backlight Type	OLED	_		_							
OLED Color	□ Yellow	Green	□ Amber	□ White							
Temperature Range	Wide T	emp., 3.3V, S	Single Supply	Voltage							
Frame	Black										

### **TO BE VERY CAREFUL !**

The OLED driver ICs are made by CMOS process, which are very easy to be damaged by static charge, make sure the user is grounded when handling the LCM.

### This parts comply with RoHs



### **ABSOLUTE MAXIMUM RATING**

(1) Electrical Absolute Ratings

Item	Symbol	Min.	Max.	Unit	Note
Power Supply for Logic	V <sub>DD</sub> -V <sub>SS</sub>	-0.3	5.5	Volt	
Power Supply for OLED	V <sub>DD</sub> -V <sub>CC</sub>	-0.3	13.0	Volt	
Input Voltage	VI	-0.3	V <sub>DD</sub>	Volt	
Life Time (100 cd/m <sub>2</sub> )	$V_{CC} = 7.25V$ $T_a = 25^{\circ}C$ 50% RH	50,000		Hour	

#### (2) Environmental Absolute Maximum Ratings

	Wide Temperature								
Item	Oper	ating	Storage						
	Min,	Max.	Min,	Max.					
Ambient Temperature	-40	+70	-40	+85					
Humidity(without condensation)	Note	e 4,5	Note	e 4,6					

Note 2 Ta 50 : 80% RH max

Ta>50 : Absolute humidity must be lower than the humidity of 85% RH at 50

Note 3 Ta at -20 will be<48hrs at 70 will be <120hrs when humidity is higher than 70%.

Note 4 Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

Note 5 Ta 70 : 75RH max

Ta>70 : absolute humidity must be lower than the humidity of 75% RH at 70

Note 6 Ta at -30 will be <48 hrs, at 80 will be <120 hrs when humidity is higher than 70%.

# **ELECTRICAL CHARACTERISTICS**

Item	Symbol	Condition	Min.	Тур	Max.	Unit	note
Power Supply for Logic	$V_{DD}$ - $V_{SS}$	-	2.4	3.3	3.6	Volt	
Power Supply for OLED	V <sub>CC</sub> -V <sub>SS</sub>	-	11.5	12.0	12.5	Volt	
Input Voltage	V <sub>IL</sub>	L level	0	-	$0.2 \ V_{DD}$	Volt	
	V <sub>IH</sub>	H level	$0.8 \ V_{DD}$	-	$V_{DD}$	Volt	
	V <sub>OL</sub>	L level	0	-	0.1 V <sub>DD</sub>		
Onput Voltage	V <sub>OH</sub>	H level	$0.9 \ V_{DD}$	-	V <sub>DD</sub>		
LCM Recommend		Ta = 0	-	-	-		
OLED Module	$V_O - V_{SS}$	Ta = 25	9.0	10.0	11.5	Volt	
Driving Voltage		Ta = 50	-	-	-		
Power Supply Current for OLED	I <sub>DD</sub>	$V_{DD} = 3.3 V$ $V_{O} - V_{SS} = 10.0 V$	-	50.0	80.0	mA	

#### **OPTICAL CHARACTERISTICS**

Item	Symbol	Condition	Min.	Тур	Max.	Unit	note
	f(12 o'clock)		-	75	-		
Viewing angle	b(6 o'clock)	When Cr	-	75	-	Deerree	0.10
range	l(9 o'clock)	20	-	65	-	Degree	9,10
	r(3 o'clock)		-	65	-		
Rise Time	Tr		-	40		G	
Fall Time	Tf	V <sub>O</sub> -V <sub>SS</sub>	-	40		mS	
Frame frequency	Frm	=10.0V Ta=25	-	64	-	Hz	8,10
Dark Room Contrast	Cr		-	2000:1	-		7
Brightness	L		120	150	-	cd/m²	
Peak Emission Wavelength	C.I.E (Green)	CIE1931	X=0.27 Y=0.58	X=0.31 Y=0.62	X=0.35 Y=0.66	nm	

0101-142

# **MECHANICAL SPECIFICATION**

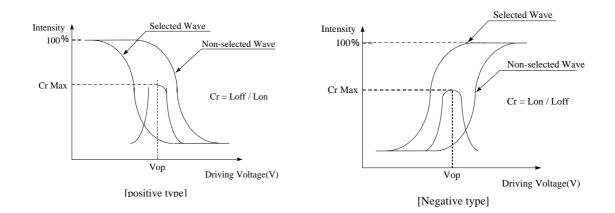
ITEM	DESCRIPTION
Product No.	SO1602A
Viewing Area	58.22(W)mm×13.52(H)mm
Module Size	80.0(W)×36.0(H)×8.5 max(D)
Dot Size	0.57(W)mm×0.67(H)mm
Dot Pitch	0.60(W)mm×0.70(H)mm
Display Format	16 characters (W)×2 lines (H)
Duty Ratio	1/16 Duty
Interface	I <sup>2</sup> C Serial
Controller	US2066 or Equivalent

### **INTERFACE PIN ASSIGNMENT**

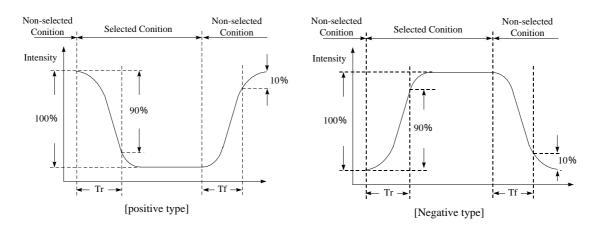
Pin No.	Pin Out	Level	Description
1	VSS	0V	Power Supply Ground
2	VDD	3.3V	Power Supply Voltage
3	/CS	L	Chip Select Signal
4	SA0	-	Slave address
5	NC		No Connection
6	NC		No Connection
7	SCL	H/L	IIC Bus Serial Clock Input
8	SDA_in	H/L	IIC Bus Serial Data
9	9 SDA_out H/L		"SDA in" and "SDA out" are tied together and serve as SDA.
10 14	NC		No Connection

#### [Note 7] Definition of Operation Voltage (Vop)

SUNLIKE DISPLAY



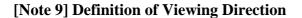
[Note 8] Definition of Response Time (Tr, Tf)

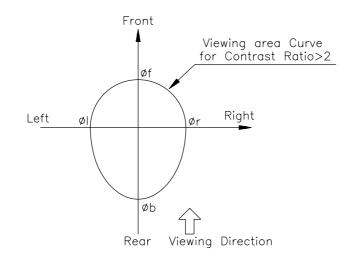


#### Conditions: Operating Voltage : Vop

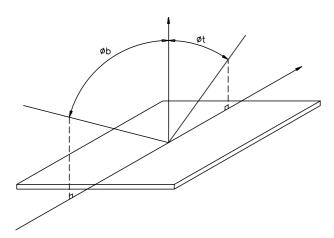
Frame Frequency : 64 Hz

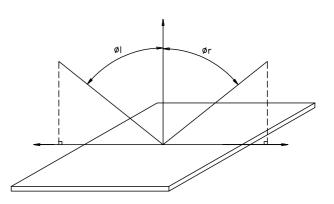
Viewing Angle( , ):  $0^{\circ}$ ,  $0^{\circ}$ Driving Wave form : 1/N duty, 1/a bias



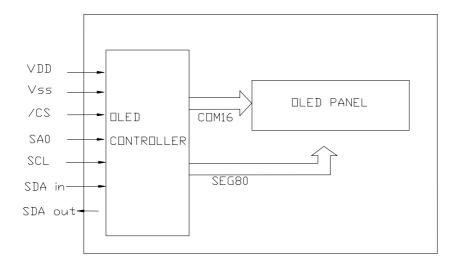


#### [Note 10] Definition of viewing angle

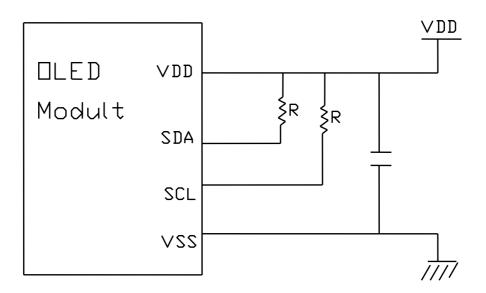


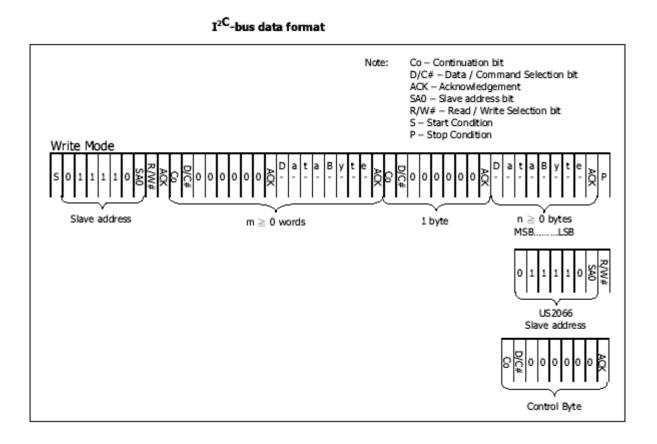


# **BLOCK DIAGRAM**



# **POWER SUPPLY**





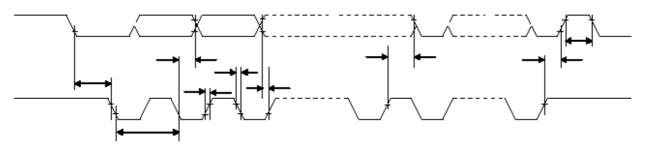
#### I<sup>2</sup>C Timing Characteristics

#### I<sup>2</sup>C Timing Characteristics

$T_{A} = 25^{\circ}C_{2}$	, V <sub>DDIO</sub> = 2.4-3.6V, V <sub>SS</sub> =0V)				
Symbol	Parameter	Min	Тур	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	2.5	-	-	us
t <sub>HSTART</sub>	Start condition Hold Time	0.6	•	-	us
t <sub>HD</sub>	Data Hold Time (for "SDA <sub>OUT</sub> " pin)	5	•	-	ns
	Data Hold Time (for "SDA <sub>IN</sub> " pin)	300	•	-	ns
t <sub>SD</sub>	Data Setup Time	100	-	-	ns
t <sub>sstart</sub>	Start condition Setup Time (Only relevant for a repeated Start condition)	0.6	•	-	us
t <sub>sstop</sub>	Stop condition Setup Time	0.6	-	-	us
t <sub>R</sub>	Rise Time for data and clock pin	-	-	300	ns
tr	Fall Time for data and clock pin	-	-	300	ns
t <sub>IDLE</sub>	Idle Time before a new transmission can start	1.3	-	-	us

Note: All timings are based on 20% to 80% of  $V_{\text{DDIO}}\text{-}V_{\text{SS}}$ 

**I2C Timing Characteristics** 



### FUNCTIONAL SPECIFICATION

#### Commands

#### Power down and Power up Sequence

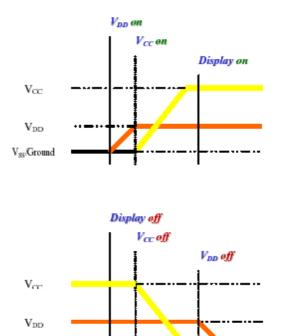
To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

Power up Sequence:

- 1. Power up V<sub>DD</sub>
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up V<sub>CC</sub>
- Delay 100ms (When V<sub>CC</sub> is stable)
- 7. Send Display on command

#### Power down Sequence:

- 1. Send Display off command
- 2. Power down V<sub>CC</sub>
- Delay 100ms (When V<sub>CC</sub> is reach 0 and panel is completely discharges)
- Power down V<sub>DD</sub>



#### Note :

 Since an ESD protection circuit is connected between V<sub>DD</sub> and V<sub>CC</sub> inside the driver IC, V<sub>CC</sub> becomes lower than V<sub>DD</sub> whenever V<sub>DD</sub> is ON and V<sub>CC</sub> is OFF.

Vss/Ground

- 2) V<sub>CC</sub> should be kept float (disable) when it is OFF.
- 3) Power Pins (V<sub>DD</sub>, V<sub>CC</sub>) can never be pulled to ground under any circumstance.
- 4) V<sub>DD</sub> should not be power down before V<sub>CC</sub> power down.

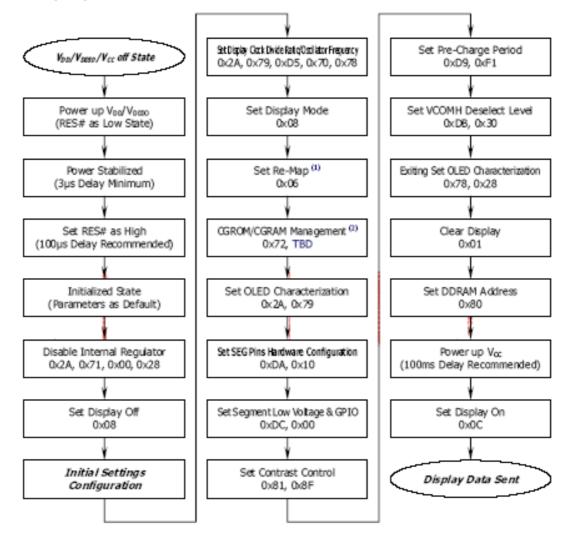
# **RESET CIRCUIT**

When RES# input is low, the chip is initialized with the following status:

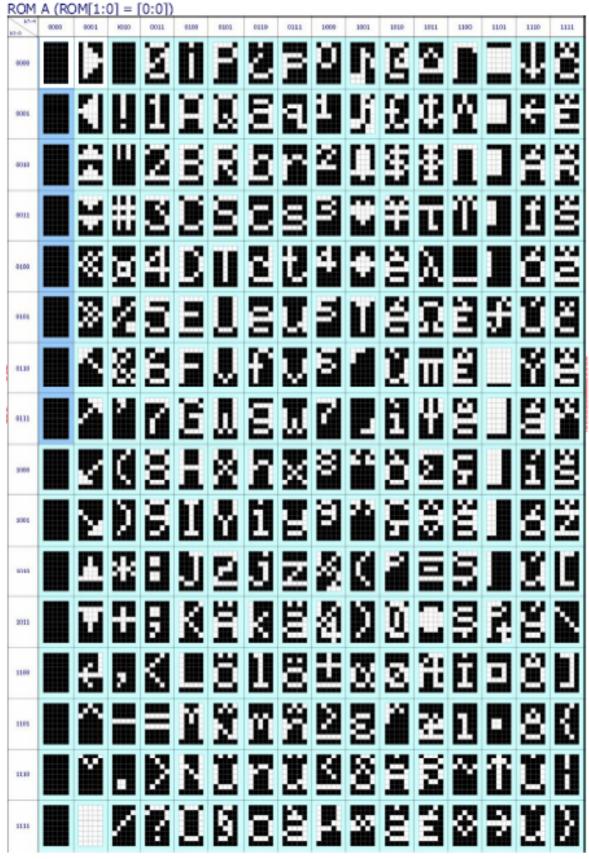
- 1. Display off, Cursor off, Blink off.
- 2. Power Down off.
- 3. 5-dot font is default.
- 4. Display Shift Disable.
- 5. CGRAM address is 00h. SEGRAM address is 00h.
- 6. DDRAM address is 00h.
- 7. Display start line is set at display RAM address 0
- 8. Column address counter is set at 0
- 9. Normal scan direction of the COM outputs
- 10. Contrast control register is set at 7Fh

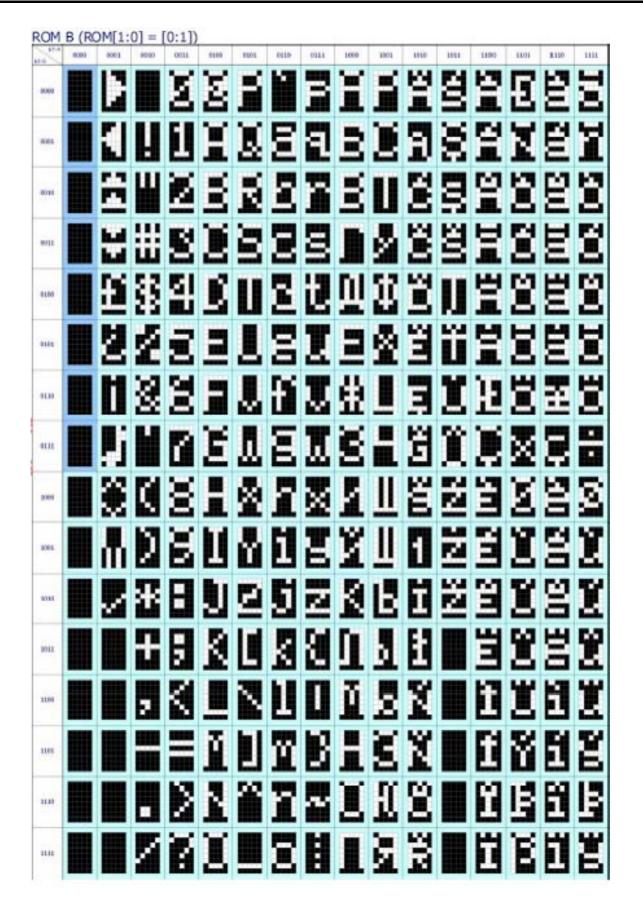
### **ACTUAL APPLICATION EXAMPLE**

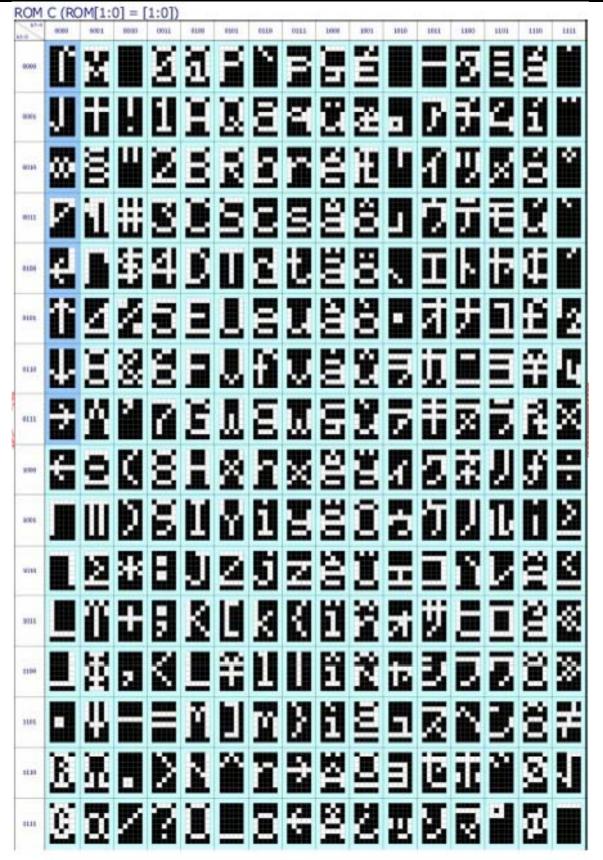
#### <Power up Sequence>



# **US2066 CGROM CHARACTER CODE**







# Commands

Instruction				In	struct	ion co	de				Description	Execution Time(Fosc	POR
instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	is 540 kHz)	Hex
IS=X, RE=	X, S	5 <b>D=0</b>											
Clear Display	0	0	0	0	0	0	0	0	0	1	Write"20H"toDDRAM.and set DDRAM address to"00H" from AC	1.52 mS	
IS=X, RE=	:0 , S	D=0											
Return Home	0	0	0	0	0	0	0	0	1	*	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52 mS	
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37 µS	06H
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1 : entire display on C=1 : cursor on B=1 : blink on	37 µS	08H
Function Set	0	0	0	0	1	*	N	DH	RE (0)	IS	N : number of line is 2/1 DH : Double height font control for 2-line mode enable/disable Extension register RE Extension register IS	37 µS	20H
IS=0, RE=	0 , SI	D=0											
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	*	*	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	37 µS	10H
Set CG RAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	37 µS	
IS=0 , RE=	X,S	D=0											
Set DDRAM RAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	37 µS	
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 µS	
Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	37 µS	
Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	37 µS	

Instruction				In	struct	ion co	de				Description	Execution Time(Fosc	POR
msu uction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	is 540 kHz)	Hex
IS=0, RE=1	IS=0, RE=1, SD=0												
Function Set	0	0	0	0	1	*	N	BE	<b>RE</b> (1)	REV	N : Number of line is 2/1 BE : CGRAM blink enable RE(1) : Extension register REV : Reverse bit	37 µS	20H
Entry Mode Set	0	0	0	0	0	0	0	1	BDC	BDS	Common bi-direction function BDC= "0" : COM31->COM0 BDC= "1" : COM0-> COM31 Segment bi-direction function BDS= "0" : SEG99-> SEG0 BDS= "1" : SEG0-> SEG99	37 µS	06H
Set Scroll Quantity	0	0	1	*	SQ5	SQ4	SQ3	SQ2	SQ1	SQ0	Set the quantity of horizontal dot scroll. Scroll Quantity (0 - 48)	37 µS	80H
OLED Characterization	0	0	0	1	1	1	1	0	0	SD	SD=0 : Normal register SD=1 : Extension register	37 µS	<b>78</b> H
Double Height (4-line)/ Display-dot shift	0	0	0	0	0	1	UD2	UD1	*	DH'	UD2, UD1: Assign different double height formats, DH': Display shift enable selection bit.	37 µS	1CH
IS=1, RE=1	l, SD	0=0											
Shift / Scroll Enable	0	0	0	0	0	1	DS4/ HS4	DS3/ HS3	DS2/ HS2	DS1/ HS1	When DH'=1 Shift Enable DS : Display shift per line enable When DH'=0 Scroll Enable HS : Horizontal scroll per line enable	37 µS	1FH

# Model No: SO1602A

Instruction				In	struct	ion co	ode				Description	Execution Time(Fosc	POR
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	is 540 kHz)	Hex
IS=X,RE=	1 , SI	D=0											
Extended Function Set	0	0	0	0	0	0	1	FW	B/W	NW	FW : Font Width control B/W : Black/White Inversion enable bit NW : 4 Line mode enable bit	37 µS	08H
Function Selection A	0 1	0 0	0 A7	1 A6	1 A5	1 A4	0 A3	0 A2	0 A1	1 A0	This double byte command enable or disable the internal VDD	37 µS	71H [5CH]
Function Selection B	0 1	0 0	0 *	1 *	1 *	1 *	0 RO1	0 RO0	1 OP1	0 OP0	Beside using CGROM           OP[1:0]         CGROM           O0b         240         8           01b         248         8           10b         250         6           11b         256         0           Select character ROM         RO[1:0]         ROM           00b         A         0           01b         B         10b           10b         C         11b	37 μS	72H [0FH]
Set Contrast Control	0 0	0 0	1 A7	0 A6	0 A5	0 A4	0 A3	0 A2	0 A1	1 A0	This command sets the Contrast Setting of the display.	37 µS	81H [7FH]
Set Display Clock Divide Ratio/Oscillator Frequency	0 0	0 0	1 A7	1 A6	0 A5	1 A4	0 A3	1 A2	0 A1	1 A0	Display Clock Divide Ratio (A[3:0]) Oscillator Frequency (A[7:4])	37 µS	D5H [70H]
Set Phase Length	0 0	0 0	1 A7	1 A6	0 A5	1 A4	1 A3	0 A2	0 A1	1 A0	This double byte command sets the length of phase 1 and 2 of segment waveform of the driver.	37 µS	D9H [78H]
Set SEG Pins Hardware Configuration	0 0	0 0	1 0	1 0	0 A5	1 A4	1 0	0 0	1 0	0 0	This double byte command changes the mapping between the display	37 µS	DAH [10H]
Set VCOMH Deselect Level	0 0	0 0	1 0	1 A6	0 A5	1 A4	1 0	0 0	1 0	1 0	A [6:4] Hex         V COMH deselect           code         level           000b         00h         0.65xVcc           001b         10h         0.71xVcc           010b         20h         0.77xVcc           011b         30h         0.83xVcc           100b         40h         1xVcc	37 μS	DBH [40H]
Function Selection C	0 0	0 0	1 0	1 A7	0 0	1 0	1 0	1 0	0 A1	0 A0	This double byte command consists of two functions	37 µS	DCH [00H]
Crosstalk Compensation	0	0	1	1	0	1	1	1	1	1	TBD	37 µS	DFH

Note

(1) POR stands for Power On Reset Values
(2) "\*"and "x" stand for "Don't care"
(3) The locked OLED driver IC MCU interface prohibits all commands access except logic bit SD is set to 1b

(4) Refer to Table 0-1 and

(5) Table 0-2 for the details of logic bits IS, RE and SD.

(6) Cursor & Blink is ON, that performs alternate between all the high data and display character at the cursor position.
 If fosc has 540kHz frequency, blinking has 370 ms interval.

### HANDLING PRECAUTION

#### 1. Mounting Method

The panel of the OLED Module consists of two thin glass plates with polarizes which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the OLED Modules.

#### 2. Caution of OLED handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and Wipe lightly.

-Isopropyl alcohol

-Ethyl alcohol

-Trichlorotriflorothane

Do not wipe the display surface with dry or hard materials that will damage the polarize surface.

Do not use the following solvent :

-Water

-Kettle

-Aromatics

#### 3. Caution against static charge

The OLED Module use C-MOSLSI drivers, so we recommend end that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

#### 4. Packaging

-Modules use OLED elements, and must be treated as such. Avoid in tense shock and falls from a height.

-To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

#### 5. Caution for operation

-It is indispensable to drive LCD's with in the specified voltage limit since the higher voltage than the limit shorten LCD life.

An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.

-Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature range.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.

 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the relative condition of 40 , 50% RH or less is required.

#### 6. Storage

In the case of storing for a long period of time (for instance. For years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.

- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.

-Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

#### 7. Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol. Which should be burned up later.

- When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.